

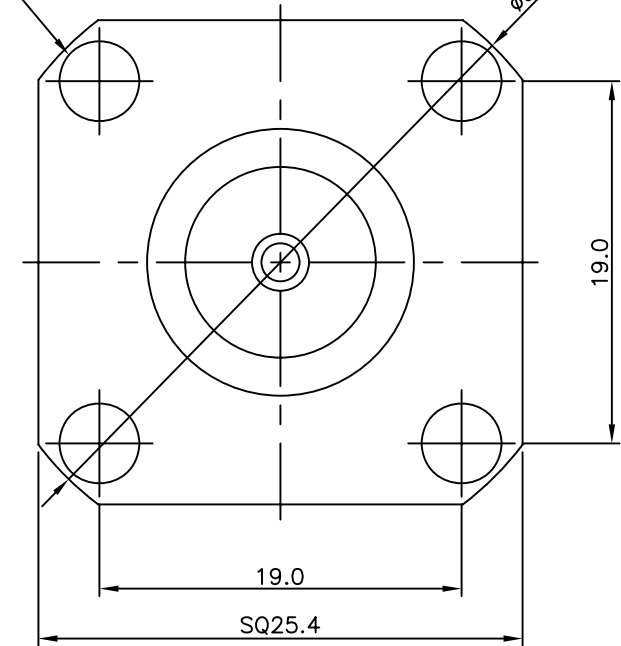
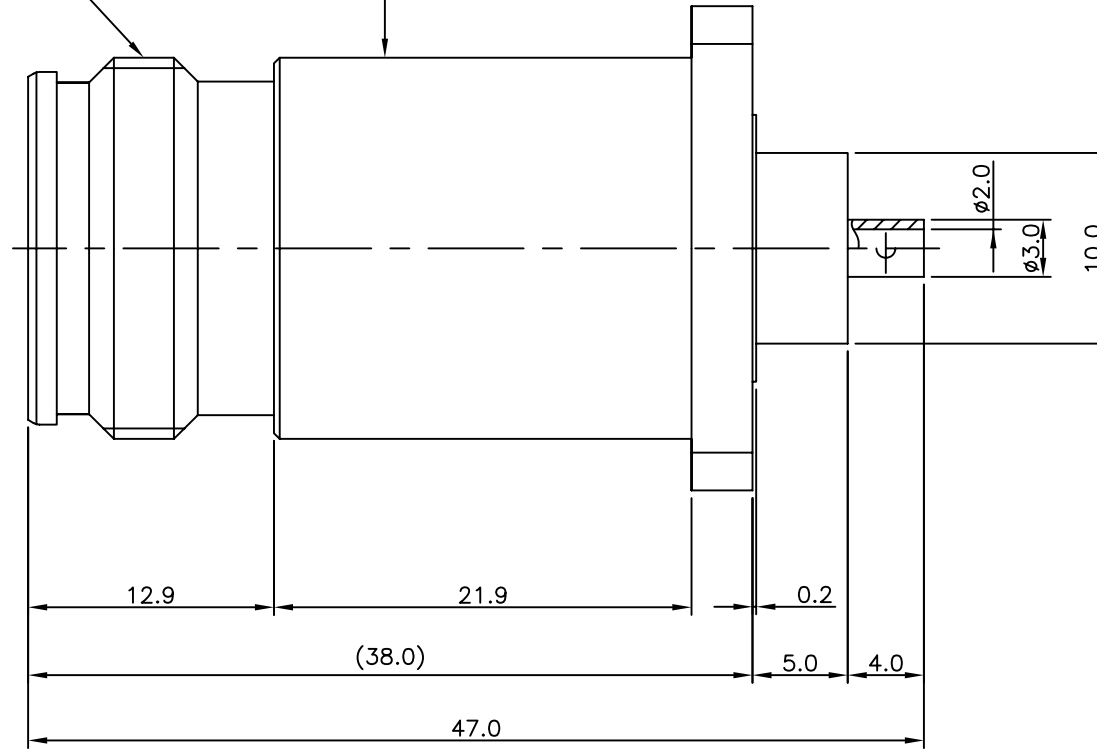
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019. 05. 09.

M20x1.0

ø20.0

4-ø4.2 THRU

ø31.8



ELECTRICAL DATA

1. IMPEDANCE : 50ohm
2. FREQUENCY RANGE : DC~3GHz
3. VSWR (Max) : 1.2
4. INSERTION LOSS : 0.3dB (Max)
5. PIMD (-43dBm / 2tone) 3rd Order IMD : -160dBc (Min.)

4	JACK	1	BeCu C17300	Silver Plate (3μm)	DJA00228-5/A
3	INSULATOR	1	TEFLON		DIN03044-N/1
2	CONTACT	1	BeCu C17300	Silver Plate (6μm)	DCT04009-5/1
1	BODY	1	MBsBD C3604BD-F	SUCO Plate	DBD04487-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2019. 05. 09.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE 4.3/10 DIN50 SOLDER END JS-4H
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	UNIT	A4 DWG NO. CN03832-7/1 REVISION I R SHEET 1 of 1
		2.5/1	mm	